

BGA Pad = 0.254mm
BGA Pad Soldermask = 0.4064mm
BGA Via = 0.3048mm Pad
0.1524mm Drill
BGA Tracks = 0.1016mm Width
0.1016mm Spacing
NUMBER OF LAYERS = 6



DRILL CHART: TOP to L4-SIG2			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
.	6.0	PLATED	33

DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
.	6.0	PLATED	55